

- **Low Insertion Loss**
- **5.0 X 7.0 mm Surface-Mount Case**
- **Complies with Directive 2002/95/EC (RoHS)**

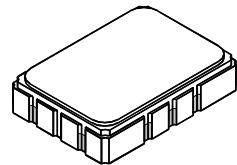


#### Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for lead-free soldering - Max Soldering Profile	260°C for 30 s	

**SF1145B**

**427.250 MHz  
SAW Filter**



**SMP-03**

#### Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	$f_C$			427.250		MHz
Passband	Insertion Loss at $f_C$	IL			3.5	dB
	1.5 dB Passband	BW <sub>1</sub>	1, 2	±15		kHz
Rejection (referenced to $f_C=427.250$ MHz)	$f_C \pm 1.5$ MHz		5			
	$f_C \pm 6.0$ MHz		20			
	$f_C \pm 50$ MHz		50			
Operating Temperature Range	$T_A$	1	-40		+85	°C
Differential Input and Output Impedance after matching				50 ohms		
Case Style				SMP-03 7 x 5 mm Nominal Footprint		
Lid Symbolization (YY=year, WW=week, S=shift) See note 4		6		RFM SF1145B YYWWS		

#### Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others

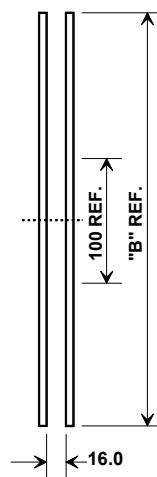
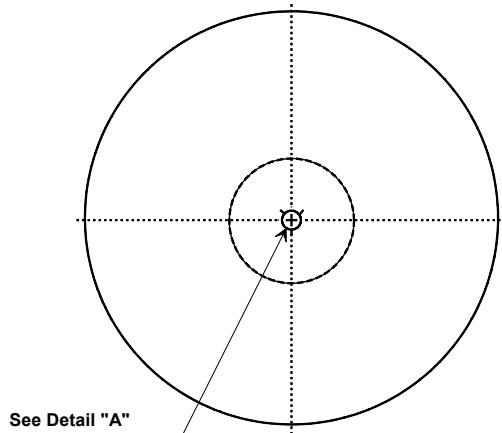


**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

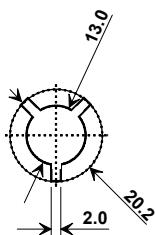
#### NOTES:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency,  $f_C$ .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

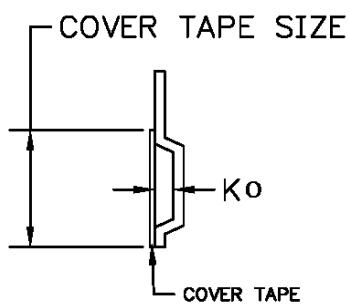
## Tape and Reel Specifications



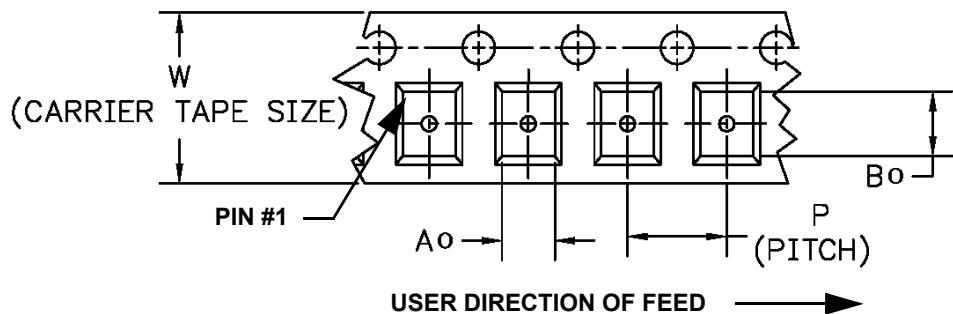
"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000



### COMPONENT ORIENTATION and DIMENSIONS



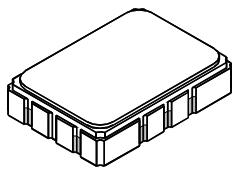
Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm



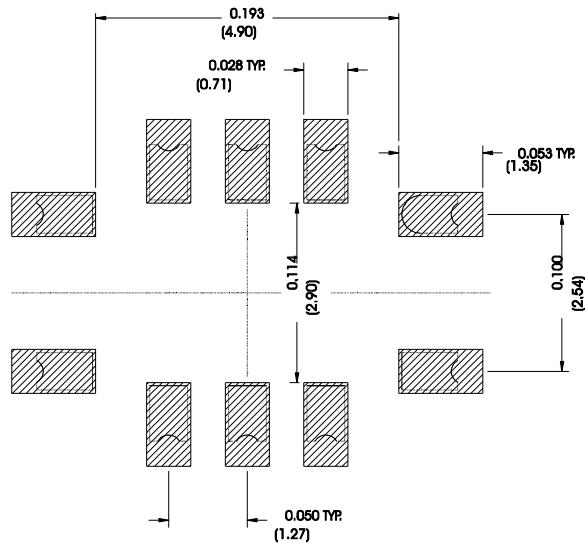
# SMP-03 Case

## 10-Terminal Ceramic Surface-Mount Case

7 x 5 mm Nominal Footprint



Recommended PCB Footprint



Dimension	Case Dimensions			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D		0.60			0.024	
E		2.54			0.100	
H		1.0			0.039	
J		5.00			0.197	
K		3.00			0.118	
P		1.27			0.050	

Electrical Connections		
Connection	Terminals	
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground	All others	
Single Ended Operation	Return is ground	
Differential Operation	Return is hot	

Materials	
Solder Pad Termination	Au plating 30 - 60 $\mu$ inches (76.2-152 $\mu$ M) over 80-200 $\mu$ inches (203-508 $\mu$ M) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 $\mu$ inches Thick
Body	$\text{Al}_2\text{O}_3$ Ceramic
Pb Free	

